**Winbond**
Electronics Corp.

# 512K × 8 CMOS FLASH MEMORY WITH LPC INTERFACE

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## 1. GENERAL DESCRIPTION

The W39V040B is a 4-megabit, 3.3-volt only CMOS flash memory organized as 512K × 8 bits. For flexible erase capability, the 4Mbits of data are divided into 8 uniform sectors of 64 Kbytes. The device can be programmed and erased in-system with a standard 3.3V power supply. A 12-volt VPP is required for accelerated program. The unique cell architecture of the W39V040B results in fast program/erase operations with extremely low current consumption. This device can operate at two modes, Programmer bus interface mode, Low pin count (LPC) bus interface mode. As in the Programmer interface mode, it acts like the traditional flash but with a multiplexed address inputs. But in the LPC interface mode, this device complies with the Intel LPC specification. The device can also be programmed and erased using standard EPROM programmers.

## 2. FEATURES

- Single 3.3-volt operations:
  - 3.3-volt Read
  - 3.3-volt Erase
  - 3.3-volt Program
- Fast Program operation:
  - Byte-by-Byte programming: 9 $\mu$S (typ.) (VPP = 12V)
  - Byte-by-Byte programming: 12 $\mu$S (typ.) (VPP = Vcc)
- Fast Erase operation:
  - Sector erase 0.6 Sec. (typ.)
- Fast Read access time: Tkq 11 nS
- Endurance: 10K cycles (typ.)
- Twenty-year data retention
- 8 Even sectors with 64K bytes
- Any individual sector can be erased

- Hardware protection:
  - #TBL supports 64-Kbyte Boot Block hardware protection
  - #WP supports the whole chip except Boot Block hardware protection
- Low power consumption
  - Active current: 15 mA (typ. for LPC read mode)
- Automatic program and erase timing with internal VPP generation
- End of program or erase detection
  - Toggle bit
  - Data polling
- Latched address and data
- TTL compatible I/O
- Available packages: 32L PLCC, 32L STSOP 32L PLCC Lead free, 32L STSOP Lead free

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## 3. PIN CONFIGURATIONS



NC — 1
NC — 2
NC — 3
VSS — 4
MODE — 5
A10(FGPI4) — 6
R/#C(CLK) — 7
VDD — 8
Vpp — 9
#RESET — 10
A9(FGPI3) — 11
A8(FGPI2) — 12
A7(FGPI1) — 13
A6(FGPI0) — 14
A5(#WP) — 15
A4(#TBL) — 16

32L STSOP

32 — #OE(#INIT)
31 — #WE(#LFRAM
30 — RY/#BY(RSV)
29 — DQ7(RSV)
28 — DQ6(RSV)
27 — DQ5(RSV)
26 — DQ4(RSV)
25 — DQ3(LAD3)
24 — VSS
23 — DQ2(LAD2)
22 — DQ1(LAD1)
21 — DQ0(LAD0)
20 — A0(ID0)
19 — A1(ID1)
18 — A2(ID2)
17 — A3(ID3)

32L PLCC

A7(FGPI1) — 5
A6(FGPI0) — 6
A5(#WP) — 7
A4(#TBL) — 8
A3(ID3) — 9
A2(ID2) — 10
A1(ID1) — 11
A0(ID0) — 12
DQ0(LAD0) — 13

29 — MODE
28 — VSS
27 — NC
26 — NC
25 — VDD
24 — #OE(#INIT)
23 — #WE(#LFRAM)
22 — RY/#BY(RSV)
21 — DQ7(RSV)

## 4. BLOCK DIAGRAM



## 5. PIN DESCRIPTION

| SYM. | INTERFACE | | PIN NAME |
|------|-----|-----|----------|
| | PGM | LPC | |
| MODE | * | * | Interface Mode Selection |
| #RESET | * | * | Reset |
| #INIT | | * | Initialize |
| #TBL | | * | Top Boot Block Lock |
| #WP | | * | Write Protect |
| CLK | | * | CLK Input |
| FGPI[4:0] | | * | General Purpose Inputs |
| ID[3:0] | | * | Identification Inputs They Are Internal Pull Down to Vss |
| LAD[3:0] | | * | Address/Data Inputs |
| #LFRAM | | * | LPC Cycle Initial |
| R/#C | * | | Row/Column Select |
| A[10:0] | * | | Address Inputs |
| DQ[7:0] | * | | Data Inputs/Outputs |
| #OE | * | | Output Enable |
| #WE | * | | Write Enable |
| RY/#BY | * | | Ready/ Busy |
| VDD | * | * | Power Supply |
| VSS | * | * | Ground |
| VPP | * | * | Accelerate Program Power Supply |
| RSV | * | * | Reserved Pins |
| NC | * | * | No Connection |

## 6. FUNCTIONAL DESCRIPTION

### 6.1 Interface Mode Selection and Description

This device can operate in two interface modes, one is Programmer interface mode, and the other is LPC interface mode. The Mode pin of the device provides the control between these two interface modes. These interface modes need to be configured before power up or return from #RESET. When ic (Mode) pin is set to V$_{DD}$, the device will be in the Programmer mode; while the Mode pin is set to low state (or leaved no connection), it will be in the LPC mode. In Programmer mode, this device just behaves like traditional flash parts with 8 data lines. But the row and column address inputs are multiplexed. The row address are mapped to the higher internal address A[18:11]. And the column address are mapped to the lower internal address A[10:0]. For LPC mode, it complies with the LPC Interface Specification, through the LAD[3:0] to communicate with the system chipset .

### 6.2 Read (Write) Mode

In Programmer interface mode, the read (write) operation of the W39V040B is controlled by #OE (#WE). The #OE (#WE) is held low for the host to obtain (write) data from (to) the outputs (inputs). #OE is the output control and is used to gate data from the output pins. The data bus is in high impedance state when #OE is high.   As for in the LPC interface mode, the read or write is determined by the "START CYCLE ". Refer to the LPC cycle definition and timing waveforms for further details.

### 6.3 Reset Operation

The #RESET input pin can be used in some application.   When #RESET pin is at high state, the device is in normal operation mode.   When #RESET pin is at low state, it will halt the device and all outputs will be at high impedance state.   As the high state re-asserted to the #RESET pin, the device will return to read or standby mode, it depends on the control signals.

### 6.4 Boot Block Operation and Hardware Protection at Initial- #TBL & #WP

There is a hardware method to protect the top boot block and other sectors. Before power on programmer, tie the #TBL pin to low state and then the top boot block will not be programmed/erased. If #WP pin is tied to low state before power on, the other sectors will not be programmed/erased.

In order to detect whether the boot block feature is set on or not, users can perform software command sequence: enter the product identification mode (see Command Codes for Identification/Boot Block Lockout Detection for specific code), and then read from address 7FFF2(hex). You can check the DQ2/DQ3 at the address 7FFF2 to see whether the #TBL/#WP pin is in low or high state. If the DQ2 is "0", it means the #TBL pin is tied to high state. In such condition, whether boot block can be programmed/erased or not will depend on software setting. On the other hand, if the DQ2 is "1", it means the #TBL pin is tied to low state, then boot block is locked no matter how the software is set. Like the DQ2, the DQ3 inversely mirrors the #WP state. If the DQ3 is "0", it means the #WP pin is in high state, then all the sectors except the boot block can be programmed/erased. On the other hand, if the DQ3 is "1", then all the sectors except the boot block are programmed/erased inhibited.

To return to normal operation, perform a three-byte command sequence (or an alternate single-byte command) to exit the identification mode. For the specific code, see Command Codes for Identification/Boot Block Lockout Detection.

### 6.5 Sector Erase Command

Sector erase is a six-bus cycles operation. There are two "unlock" write cycles, followed by writing the "set-up" command. Two more "unlock" write cycles then follows by the Sector erase command. The

Sector address (any address location within the desired Sector) is latched on the rising edge of R/#C in programmer mode, while the command (30H) is latched on the rising edge of #WE.

Sector erase does not require the user to program the device prior to erase. When erasing a Sector, the remaining unselected sectors are not affected. The system is not required to provide any controls or timings during these operations.

The automatic Sector erase begins after the erase command is completed, right from the rising edge of the #WE pulse for the last Sector erase command pulse and terminates when the data on DQ7, Data Polling, is "1" at which time the device returns to the read mode. Data Polling must be performed at an address within any of the sectors being erased.

Refer to the Erase Command flow Chart using typical command strings and bus operations.

## 6.6  Program Operation

The W39V040B is programmed on a byte-by-byte basis. Program operation can only change logical data "1" to logical data "0." The erase operation, which changed entire data in main memory and/or boot block from "0" to "1", is needed before programming.

The program operation is initiated by a 4-byte command cycle (see Command Codes for Byte Programming). The device will internally enter the program operation immediately after the byte-program command is entered. The internal program timer will automatically time-out ($9\mu S$ typ. - $T_{BP}$) once it is completed and then return to normal read mode. Data polling and/or Toggle Bits can be used to detect end of program cycle.

## 6.7  Hardware Data Protection

The integrity of the data stored in the W39V040B is also hardware protected in the following ways:

(1) Noise/Glitch Protection: A #WE pulse of less than 5 nS in duration will not initiate a write cycle.
(2) $V_{DD}$ Power Up/Down Detection: The programming and read operation are inhibited when $V_{DD}$ is less than 2.0V typical.
(3) Write Inhibit Mode: Forcing #OE low or #WE high will inhibit the write operation. This prevents inadvertent writes during power-up or power-down periods.

## 6.8  WRITE OPERATION STATUS

The device provides several bits to determine the status of a program or erase operation: DQ5, DQ6, and DQ7. Each of DQ7 and DQ6 provides a method for determining whether a program or erase operation is complete or in progress. The device also offers a hardware-based output signal, RY/#BY in programmer mode, to determine whether an Embedded Program or Erase operation is in progress or has been completed.

**DQ7: #Data Polling**

The #Data Polling bit, DQ7, indicates whether an Embedded Program or Erase algorithm is in progress or completed.  Data Polling is valid after the rising edge of the final #WE pulse in the command sequence.

During the Embedded Program algorithm, the device outputs on DQ7 and the complement of the data programmed to DQ7. Once the Embedded Program algorithm has completed, the device outputs the data programmed to DQ7. The system must provide the program address to read valid status information on DQ7. If a program address falls within a protected sector, #Data Polling on DQ7 is active for about $1\mu S$, and then the device returns to the read mode.

During the Embedded Erase algorithm, #Data Polling produces "0" on DQ7. Once the Embedded

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Erase algorithm has completed, #Data Polling produces "1" on DQ7. An address within any of the sectors selected for erasure must be provided to read valid status information on DQ7.

Just before the completion of an Embedded Program or Erase operation, DQ7 may change asynchronously with DQ0-DQ6 while Output Enable (#OE) is set to low. That is, the device may change from providing status information to valid data on DQ7. Depending on when it samples the DQ7 output, the system may read the status or valid data. Even if the device has completed the program or erase operation and DQ7 has valid data, the data outputs on DQ0-DQ6 may be still invalid. Valid data on DQ7-DQ0 will appear on successive read cycles.

### RY/#BY: Ready/#Busy

The RY/#BY is a dedicated, open-drain output pin which indicates whether an Embedded Algorithm is in progress or complete. The RY/#BY status is valid after the rising edge of the final #WE pulse in the command sequence. Since RY/#BY is an open-drain output, several RY/#BY pins can be tied together in parallel with a pull-up resistor to $V_{DD}$.

When the output is low (Busy), the device is actively erasing or programming. When the output is high (Ready), the device is in the read mode or standby mode.

### DQ6: Toggle Bit

Toggle Bit on DQ6 indicates whether an Embedded Program or Erase algorithm is in progress or complete. Toggle Bit I may be read at any address, and is valid after the rising edge of the final #WE pulse in the command sequence (before the program or erase operation), and during the sector erase time-out.

During an Embedded Program or Erase algorithm operation, successive read cycles to any address cause DQ6 to toggle. The system may use either #OE to control the read cycles. Once the operation has completed, DQ6 stops toggling.

The system can use DQ6 to determine whether a sector is actively erasing. If the device is actively erasing (i.e., the Embedded Erase algorithm is in progress), DQ6 toggles. If a program address falls within a protected sector, DQ6 toggles for about 1 μs after the program command sequence is written, and then returns to reading array data.

### DQ5: Exceeded Timing Limits

DQ5 indicates whether the program or erase time has exceeded a specified internal pulse count limit. DQ5 produces "1" under these conditions which indicates that the program or erase cycle was not successfully completed.

The device may output "1" on DQ5 if the system tries to program "1" to a location that was previously programmed to "0." Only the erase operation can change "0" back to "1." Under this condition, the device stops the operation, and while the timing limit has been exceeded, DQ5 produces "1."

Under both these conditions, the system must write the reset command to return to the read mode.

### Multi-Chip Operation

Multiple devices can be wired on the single LPC bus. There are four ID pins can be used to support up to 16 devices. But in order not to violate the BIOS ROM memory space defined by Intel, Winbond W39V040A will only used 3 ID pins to allow up to 8 devices, 4Mbytes for BIOS code and 4Mbytes for registers memory space.

## 7. REGISTER FOR LPC MODE

There are two kinds of registers on this device, the General Purpose Input Registers and Product Identification Registers. Users can access these registers through respective address in the 4Gbytes memory map. There are detail descriptions in the sections below.

### 7.1 General Purpose Inputs Register for LPC Mode

This register reads the FGPI[4:0] pins on the W39V040B.This is a pass-through register which can read via memory address FBC0100(hex). Since it is pass-through register, there is no default value.

**GPI Register Table**

| BIT | FUNCTION |
|-----|----------|
| 7 – 5 | Reserved |
| 4 | Read FGPI4 pin status |
| 3 | Read FGPI3 pin status |
| 2 | Read FGPI2 pin status |
| 1 | Read FGPI1 pin status |
| 0 | Read FGPI0 pin status |

### 7.2 Identification Input Pins ID[3:0]

These pins are part of mechanism that allows multiple parts to be used on the same bus. The boot device should be 0000b. And all the subsequent parts should use the up-count strapping. Note that a 1M byte ROM will occupy two Ids. For example: a 1MByte ROM's ID is 0000b, the next ROM's ID is 0010b. These pins all are pulled down with internal resistor.

### 7.3 Product Identification Registers

In the LPC interface mode, a read from FBC, 0000(hex) can output the manufacturer code, DA(hex). A read from FBC, 0001(hex) can output the device code 54(hex).

There is an alternative software method (six commands bytes) to read out the Product Identification in both the Programmer interface mode and the LPC interface mode. Thus, the programming equipment can automatically matches the device with its proper erase and programming algorithms.

In the software access mode, a six-byte (or JEDEC 3-byte) command sequence can be used to access the product ID for programmer interface mode. A read from address 0000(hex) outputs the manufacturer code, DA(hex). A read from address 0001(hex) outputs the device code, 54(hex). The product ID operation can be terminated by a three-byte command sequence or an alternate one-byte command sequence (see Command Definition table for detail).

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## 8. TABLE OF OPERATING MODES

### 8.1 Operating Mode Selection - Programmer Mode

| MODE | PINS | | | | |
|---|---|---|---|---|---|
| | #OE | #WE | #RESET | ADDRESS | DQ. |
| Read | V$_{IL}$ | V$_{IH}$ | V$_{IH}$ | AIN | Dout |
| Write | V$_{IH}$ | V$_{IL}$ | V$_{IH}$ | AIN | Din |
| Standby | X | X | V$_{IL}$ | X | High Z |
| Write Inhibit | V$_{IL}$ | X | V$_{IH}$ | X | High Z/DOUT |
| | X | V$_{IH}$ | V$_{IH}$ | X | High Z/DOUT |
| Output Disable | V$_{IH}$ | X | V$_{IH}$ | X | High Z |

### 8.2 Operating Mode Selection - LPC Mode

Operation modes in LPC interface mode are determined by "START Cycle" when it is selected. When it is not selected, its outputs (LAD[3:0]) will be disable. Please reference to the "LPC Cycle Definition".

### 8.3 LPC Cycle Definition

| FIELD | NO. OF CLOCKS | DESCRIPTION |
|---|---|---|
| Start | 1 | "0000b" appears on LPC bus to indicate the initial |
| Cycle Type & Dir | 1 | "010Xb" indicates memory read cycle; while "011xb" indicates memory write cycle. "X" mean don't have to care. |
| TAR | 2 | Turned Around Time |
| Addr. | 8 | Address Phase for Memory Cycle. LPC supports the 32 bits address protocol. The addresses transfer most significant nibble first and least significant nibble last. (i.e. Address[31:28] on LAD[3:0] first , and Address[3:0] on LAD[3:0] last.) |
| Sync. | N | Synchronous to add wait state. "0000b" means Ready, "0101b" means Short Wait, "0110b" means Long Wait, "1001b" for DMA only, "1010b" means error, other values are reserved. |
| Data | 2 | Data Phase for Memory Cycle. The data transfer least significant nibble first and most significant nibble last. (i.e. DQ[3:0] on LAD[3:0] first, then DQ[7:4] on LAD[3:0] last.) |

## 9. TABLE OF COMMAND DEFINITION

| COMMAND DESCRIPTION | NO. OF Cycles (1) | 1ST CYCLE Addr. Data | | 2ND CYCLE Addr. Data | | 3RD CYCLE Addr. Data | | 4TH CYCLE Addr. Data | | 5TH CYCLE Addr. Data | | 6TH CYCLE Addr. Data | |
|---|---|---|---|---|---|---|---|---|---|---|---|---|---|
| Read | 1 | $A_{IN}$ | $D_{OUT}$ | | | | | | | | | | |
| Sector Erase | 6 | 5555 | AA | 2AAA | 55 | 5555 | 80 | 5555 | AA | 2AAA | 55 | SA[5] | 30 |
| Byte Program | 4 | 5555 | AA | 2AAA | 55 | 5555 | A0 | $A_{IN}$ | $D_{IN}$ | | | | |
| Product ID Entry | 3 | 5555 | AA | 2AAA | 55 | 5555 | 90 | | | | | | |
| Product ID Exit [4] | 3 | 5555 | AA | 2AAA | 55 | 5555 | F0 | | | | | | |
| Product ID Exit [4] | 1 | XXXX | F0 | | | | | | | | | | |

**Notes:**

1. The cycle means the write command cycle not the LPC clock cycle.
2. The Column Address / Row Address are mapped to the Low / High order Internal Address. i.e. Column Address A[10:0] are mapped to the internal A[10:0], Row Address A[7:0] are mapped to the internal A[18:11]
3. Address Format: A14−A0 (Hex); Data Format: DQ7-DQ0 (Hex)
4. Either one of the two Product ID Exit commands can be used.
5. SA: Sector Address

| | |
|---|---|
| SA = 7XXXXh for Unique Sector7 (Boot Sector) | SA = 3XXXXh for Unique Sector3 |
| SA = 6XXXXh for Unique Sector6 | SA = 2XXXXh for Unique Sector2 |
| SA = 5XXXXh for Unique Sector5 | SA = 1XXXXh for Unique Sector1 |
| SA = 4XXXXh for Unique Sector4 | SA = 0XXXXh for Unique Sector0 |

## 9.1  Embedded Programming Algorithm

Start

↓

Write Program Command Sequence
(see below)

↓

#Data Polling/ Toggle bit

↓

Programming Completed

**Program Command Sequence (Address/Command):**

5555H/AAH

↓

2AAAH/55H

↓

5555H/A0H

↓

Program Address/Program Data

## 9.2  Embedded Erase Algorithm

```
                        ┌──────────────────────┐
                        │        Start         │
                        └──────────────────────┘
                                   │
                                   ▼
                        ┌──────────────────────┐
                        │ Write Erase Command  │
                        │  Sequence            │
                        │  (see below)         │
                        └──────────────────────┘
                                   │
                                   ▼
                        ┌──────────────────────┐
                        │ #Data Polling or     │
                        │  Toggle Bit          │
                        └──────────────────────┘
                                   │
                                   ▼
                        ┌──────────────────────┐
                        │  Erasure Completed   │
                        └──────────────────────┘


                     Individual Sector Erase
                       Command Sequence
                     (Address/Command):

                        ┌──────────────────────┐
                        │      5555H/AAH       │
                        └──────────────────────┘
                                   │
                                   ▼
                        ┌──────────────────────┐
                        │      2AAAH/55H       │
                        └──────────────────────┘
                                   │
                                   ▼
                        ┌──────────────────────┐
                        │      5555H/80H       │
                        └──────────────────────┘
                                   │
                                   ▼
                        ┌──────────────────────┐
                        │      5555H/AAH       │
                        └──────────────────────┘
                                   │
                                   ▼
                        ┌──────────────────────┐
                        │      2AAAH/55H       │
                        └──────────────────────┘
                                   │
                                   ▼
                        ┌──────────────────────┐
                        │  Sector Address/30H  │
                        └──────────────────────┘
```

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### 9.3 Embedded #Data Polling Algorithm



Note: SA = Valid address for programming. During a sector erase operation, a valid address is an address within any sector selected for erasure.
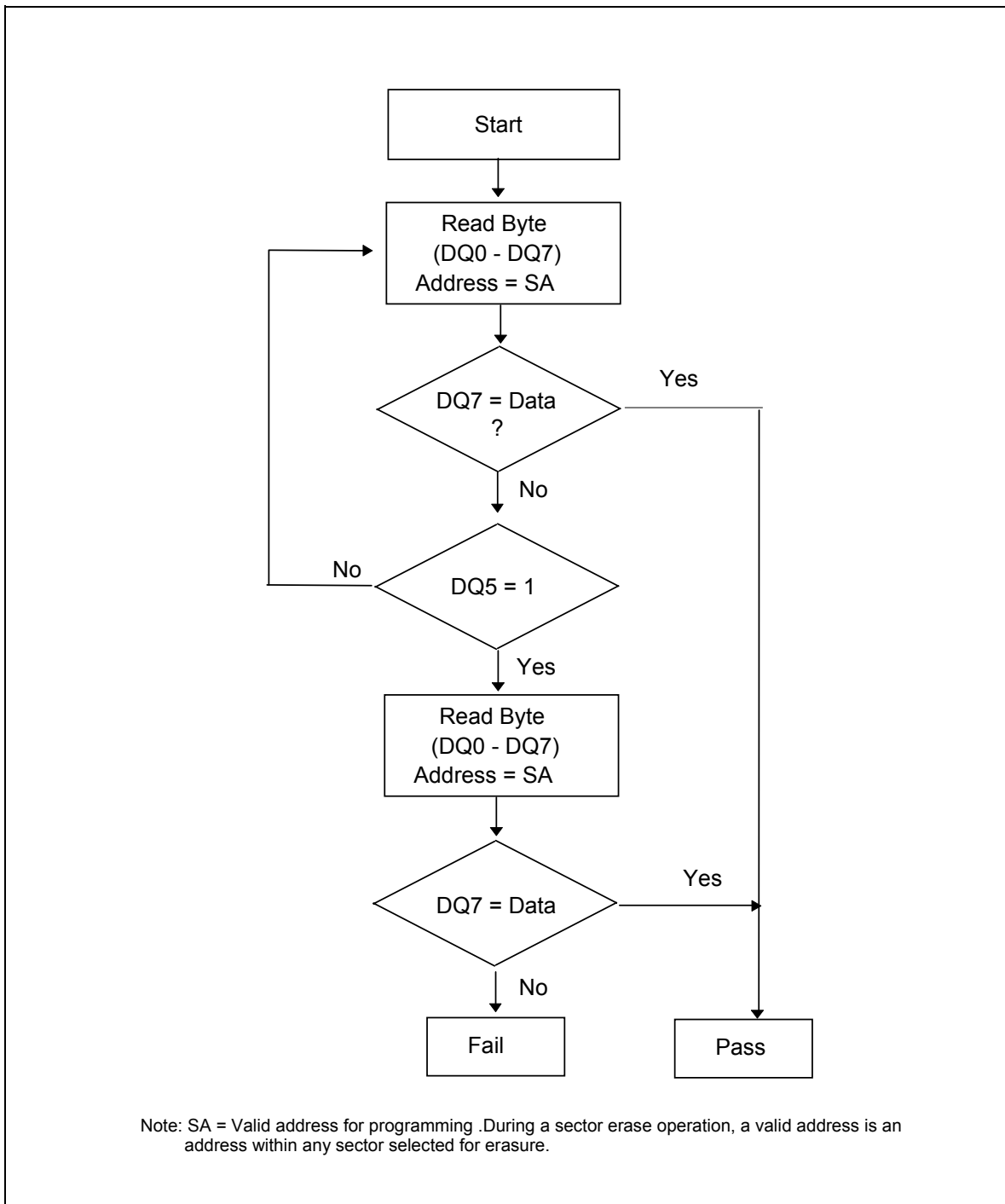
## 9.4 Embedded Toggle Bit Algorithm

```
                    ┌──────────────┐
                    │    Start     │
                    └──────┬───────┘
                           │
                    ┌──────▼───────┐
                    │  Read Byte   │
                    │  (DQ0-DQ7)   │
                    └──────┬───────┘
                           │
                    ┌──────▼───────┐
          ┌────────►│  Read Byte   │
          │         │  (DQ0-DQ7)   │
          │         └──────┬───────┘
          │                │
          │           ┌────▼────┐         No
          │          ╱ Toggle Bit ╲ ──────────────┐
          │          ╲ =Toggle ?  ╱               │
          │           └────┬────┘                 │
          │                │ Yes                   │
          │           ┌────▼────┐                  │
          │   No      ╱         ╲                  │
          └───────────╲ DQ5 = 1 ?╱                 │
                       └────┬────┘                 │
                            │ Yes                   │
                     ┌──────▼───────┐               │
                     │  Read Byte   │               │
                     │(DQ0-DQ7) twin│               │
                     └──────┬───────┘               │
                            │                       │
                       ┌────▼────┐        No        │
                      ╱ Toggle Bit ╲ ───────────────┤
                      ╲ =Toggle ?  ╱                 │
                       └────┬────┘                  │
                            │                        │
         ┌──────────────────▼──┐      ┌─────────────▼────────┐
         │ Program/Erase        │      │  Program/Erase       │
         │ Operation Not        │      │  Operation complete  │
         │ Complete, Write      │      │                      │
         │ Reset Command        │      │                      │
         └──────────────────────┘      └──────────────────────┘
```

Note: Recheck toggle bit because it may stop toggling as DQ5 changes to "1".
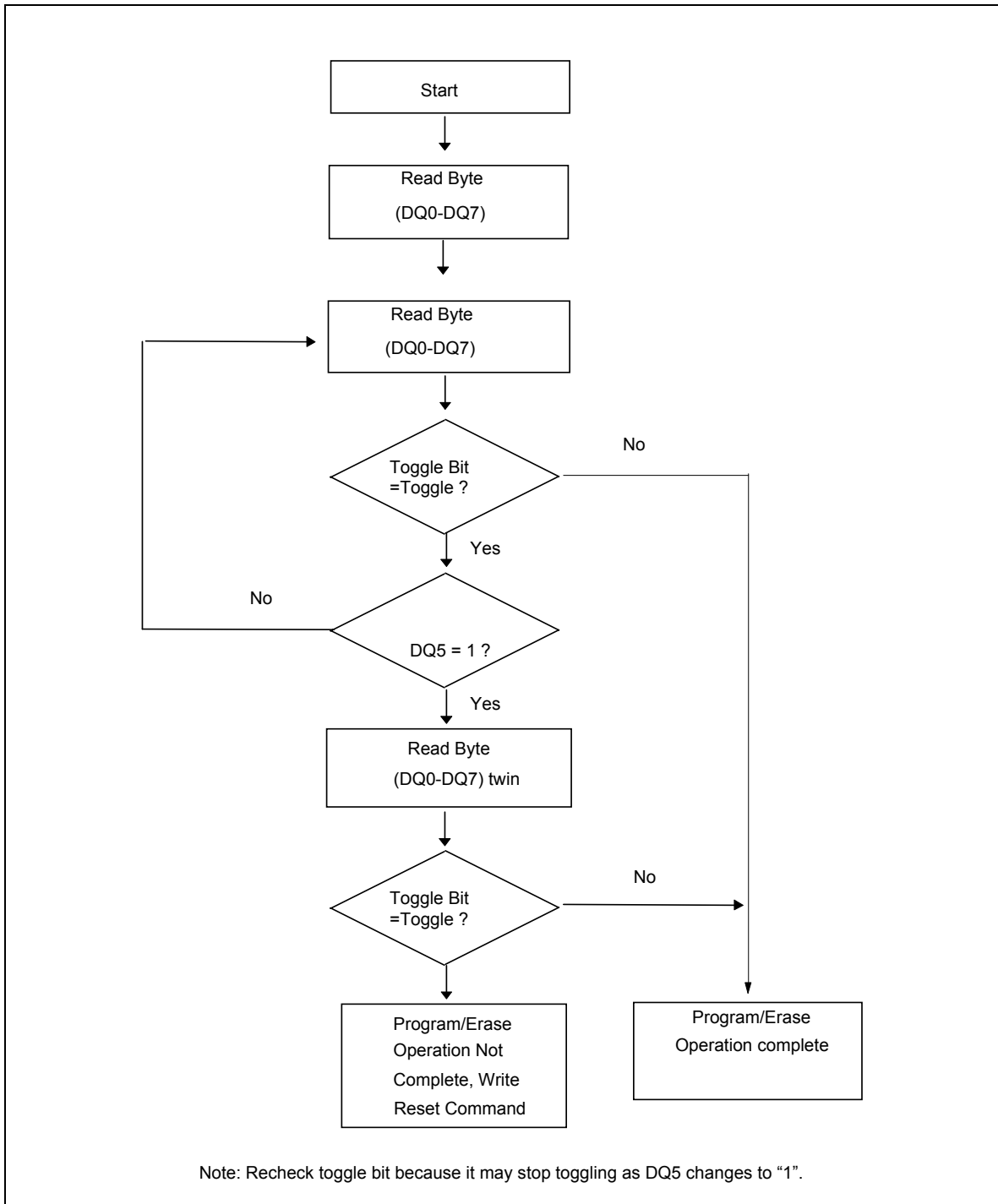
## 9.5 Software Product Identification and Boot Block Lockout Detection Acquisition Flow

**Product Identification Entry (1)**

- Load data AA to address 5555
- Load data 55 to address 2AAA
- Load data 90 to address 5555
- Pause 10 μS

**Product Identification and Boot Block Lockout Detection Mode (3)**

- Read address = 00000 data = DA (2)
- Read address = 00001 data = 54 (2)
- Read address = 7FFF2 Check DQ[3:0] of data outputs (4)

**Product Identification Exit(6)**

- Load data AA to address 5555
- Load data 55 to address 2AAA
- Load data F0 to address 5555
- Pause 10 μS
- Normal Mode (5)

Notes for software product identification/boot block lockout detection:

(1) Data Format: DQ7−DQ0 (Hex); Address Format: A14−A0 (Hex)

(2) A1−A18 = V$_{IL}$; manufacture code is read for A0 = V$_{IL}$; device code is read for A0 = V$_{IH}$.

(3) The device does not remain in identification and boot block lockout detection mode if power down.

(4) The DQ[3:2] to indicate the sectors protect status as below:

|   | DQ2 | DQ3 |
|---|---|---|
| 0 | 64Kbytes Boot Block Unlocked by #TBL hardware trapping | Whole Chip Unlocked by #WP hardware trapping Except Boot Block |
| 1 | 64Kbytes Boot Block Locked by #TBL hardware trapping | Whole Chip Locked by #WP hardware trapping Except Boot Block |

(5) The device returns to standard operation mode.

(6) Optional 1-write cycle (write F0 (hex.) at XXXX address) can be used to exit the product identification/boot block lockout detection.

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## 10. ELECTRICAL CHARACTERISTICS

### 10.1 Absolute Maximum Ratings

| PARAMETER | RATING | UNIT |
|---|---|---|
| Operating Temperature | 0 to +70 | °C |
| Storage Temperature | -65 to +150 | °C |
| Power Supply Voltage to Vss Potential | -0.5 to +4.0 | V |
| D.C. Voltage on Any Pin to Ground Potential | -0.5 to VDD +0.5 | V |
| VPP Voltage | -0.5 to +13 | V |
| Transient Voltage (<20 nS) on Any Pin to Ground Potential | -1.0 to VDD +0.5 | V |

**Note:** Exposure to conditions beyond those listed under Absolute Maximum Ratings May adversely affect the life and reliability of the device.

### 10.2 Programmer interface Mode DC Operating Characteristics

($V_{DD}$ = 3.3V ± 0.3V, $V_{SS}$ = 0V, $T_A$ = 0 to 70° C)

| PARAMETER | SYM. | TEST CONDITIONS | LIMITS | | | UNIT |
|---|---|---|---|---|---|---|
| | | | MIN. | TYP. | MAX. | |
| Power Supply Current | Icc | In Read or Write mode, all DQs open Address inputs = 3.0V/0V, at f = 3 MHz | - | 15 | 30 | mA |
| Input Leakage Current | ILI | VIN = VSS to VDD | - | - | 90 | μA |
| Output Leakage Current | ILO | VOUT = VSS to VDD | - | - | 90 | μA |
| Input Low Voltage | VIL | - | -0.5 | - | 0.8 | V |
| Input High Voltage | VIH | - | 2.0 | - | VDD +0.5 | V |
| Output Low Voltage | VOL | IOL = 2.1 mA | - | - | 0.45 | V |
| Output High Voltage | VOH | IOH = -0.1mA | 2.4 | - | - | V |

## 10.3 LPC Interface Mode DC Operating Characteristics

($V_{DD}$ = 3.3V $\pm$ 0.3V, $V_{SS}$= 0V, $T_A$ = 0 to 70° C)

| PARAMETER | SYM. | TEST CONDITIONS | LIMITS | | | UNIT |
|---|---|---|---|---|---|---|
| | | | MIN. | TYP. | MAX. | |
| Power Supply Current Read | Icc | All $I_{out}$ = 0A, CLK = 33 MHz, in LPC mode operation. | - | 15 | 25 | mA |
| Power Supply Current Program/Erase | Icc | CLK = 33 MHz, in LPC mode operation. | - | 18 | 30 | mA |
| Standby Current 1 | Isb1 | LPC4 = 0.9 $V_{DD}$, CLK = 33 MHz, all inputs = 0.9 $V_{DD}$ / 0.1 $V_{DD}$ no internal operation | - | 20 | 50 | uA |
| Standby Current 2 | Isb2 | LPC4 = 0.1 $V_{DD}$, CLK = 33 MHz, all inputs = 0.9 $V_{DD}$ /0.1 $V_{DD}$ no internal operation. | - | 3 | 10 | mA |
| Input Low Voltage | $V_{IL}$ | - | -0.5 | - | 0.3 $V_{DD}$ | V |
| Input Low Voltage of #INIT | $V_{ILI}$ | - | -0.5 | - | 0.2 $V_{DD}$ | V |
| Input High Voltage | $V_{IH}$ | - | 0.5 $V_{DD}$ | - | $V_{DD}$ +0.5 | V |
| Input High Voltage of #INIT Pin | $V_{IHI}$ | - | 1.35 V | - | $V_{DD}$ +0.5 | V |
| Output Low Voltage | $V_{OL}$ | $I_{OL}$ = 1.5 mA | - | - | 0.1 $V_{DD}$ | V |
| Output High Voltage | $V_{OH}$ | $I_{OH}$ = -0.5 mA | 0.9 $V_{DD}$ | - | - | V |

## 10.4 Power-up Timing

| PARAMETER | SYMBOL | TYPICAL | UNIT |
|---|---|---|---|
| Power-up to Read Operation | $T_{PU}$. READ | 100 | µS |
| Power-up to Write Operation | $T_{PU}$. WRITE | 5 | mS |

## 10.5 Capacitance

($V_{DD}$ = 3.3V, $T_A$ = 25° C, f = 1 MHz)

| PARAMETER | SYMBOL | CONDITIONS | MAX. | UNIT |
|---|---|---|---|---|
| I/O Pin Capacitance | $C_{I/O}$ | $V_{I/O}$ = 0V | 12 | pf |
| Input Capacitance | $C_{IN}$ | $V_{IN}$ = 0V | 6 | pf |

## 10.6 Programmer Interface Mode AC Characteristics

**AC Test Conditions**

| PARAMETER | CONDITIONS |
|---|---|
| Input Pulse Levels | 0V to 0.9 $V_{DD}$ |
| Input Rise/Fall Time | < 5 nS |
| Input/Output Timing Level | 1.5V/1.5V |
| Output Load | 1 TTL Gate and $C_L$ = 30 pF |

**AC Test Load and Waveform**

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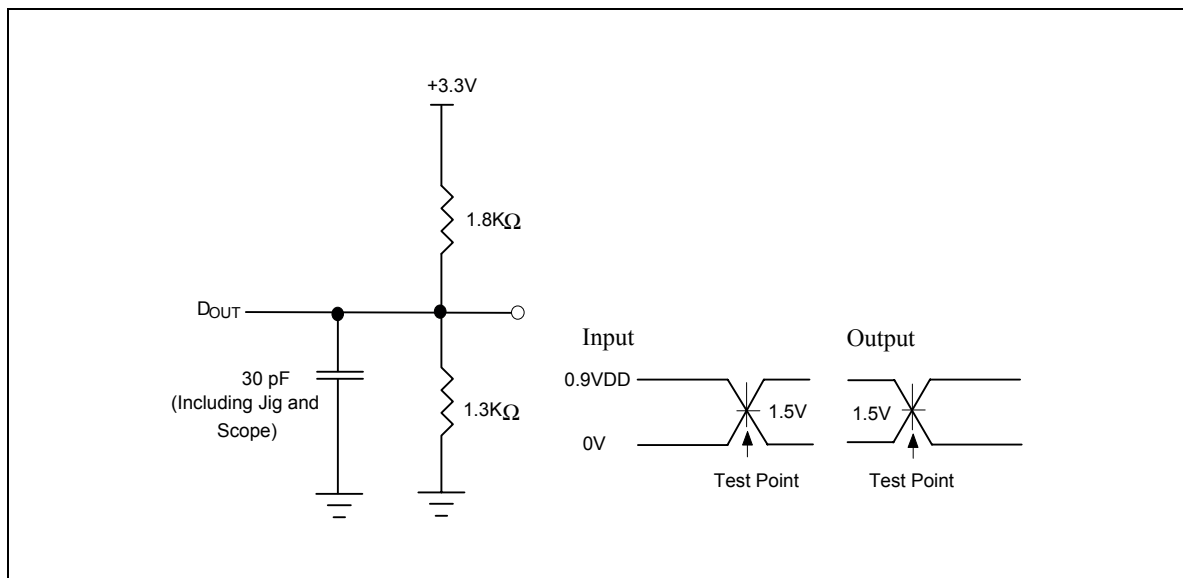
Programmer Interface Mode AC Characteristics, continued

## 10.7 Read Cycle Timing Parameters

($V_{DD}$ = 3.3V ± 0.3V, $V_{SS}$ = 0V, $T_A$ = 0 to 70° C)

| PARAMETER | SYMBOL | W39V040B | | UNIT |
|---|---|---|---|---|
| | | MIN. | MAX. | |
| Read Cycle Time | $T_{RC}$ | 350 | - | nS |
| Row / Column Address Set Up Time | $T_{AS}$ | 50 | - | nS |
| Row / Column Address Hold Time | $T_{AH}$ | 50 | - | nS |
| Address Access Time | $T_{AA}$ | - | 150 | nS |
| Output Enable Access Time | $T_{OE}$ | - | 75 | nS |
| #OE Low to Active Output | $T_{OLZ}$ | 0 | - | nS |
| #OE High to High-Z Output | $T_{OHZ}$ | - | 35 | nS |
| Output Hold from Address Change | $T_{OH}$ | 0 | - | nS |

## 10.8 Write Cycle Timing Parameters

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|
| Reset Time | $T_{RST}$ | 1 | - | - | μS |
| Address Setup Time | $T_{AS}$ | 50 | - | - | nS |
| Address Hold Time | $T_{AH}$ | 50 | - | - | nS |
| R/#C to Write Enable High Time | $T_{CWH}$ | 50 | - | - | nS |
| #WE Pulse Width | $T_{WP}$ | 100 | - | - | nS |
| #WE High Width | $T_{WPH}$ | 100 | - | - | nS |
| Data Setup Time | $T_{DS}$ | 50 | - | - | nS |
| Data Hold Time | $T_{DH}$ | 50 | - | - | nS |
| #OE Hold Time | $T_{OEH}$ | 0 | - | - | nS |
| Byte programming Time | $T_{BP}$ | - | 12 | 200 | μS |
| Sector Erase Cycle Time (Note 2) | $T_{PEC}$ | - | 0.6 | 6 | S |
| Program/Erase Valid to RY/#BY Delay | $T_{BUSY}$ | 90 | - | - | nS |

**Notes**: 1. All AC timing signals observe the following guidelines for determining setup and hold times:
   (a) High level signal's reference level is input high and (b) low level signal's reference level is input low.
      Ref. to the AC testing condition.

   2. Exclude 00H pre-program prior to erasure. (In the pre-programming step of the embedded erase algorithm,
      all bytes are programmed to 00H before erasure

## 10.9 Data Polling and Toggle Bit Timing Parameters

| PARAMETER | SYMBOL | W39V040B | | UNIT |
|---|---|---|---|---|
| | | MIN. | MAX. | |
| #OE to Data Polling Output Delay | $T_{OEP}$ | - | 350 | nS |
| #OE to Toggle Bit Output Delay | $T_{OET}$ | - | 350 | nS |
| Toggle or Polling interval (for sector erase only) (Note1) | - | 50 | - | mS |

**Note1:** Minimum timing interval between Toggle-check or Polling-check is required for sector erase only
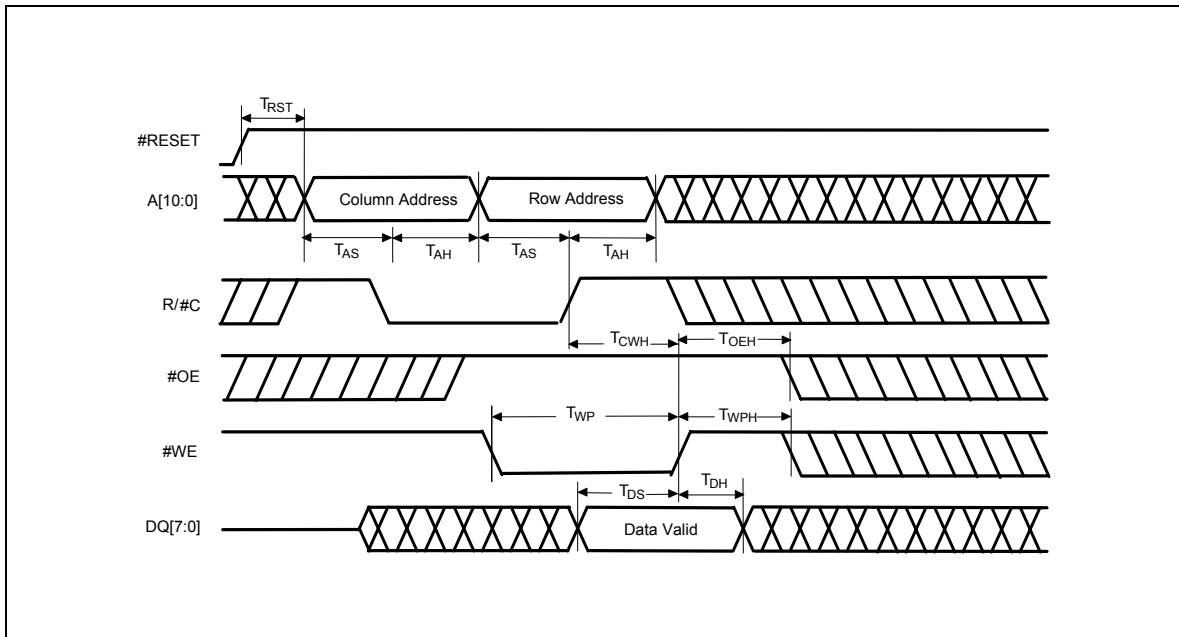
# W39V040B

## 11. TIMING WAVEFORMS FOR PROGRAMMER INTERFACE MODE

### 11.1 Read Cycle Timing Diagram
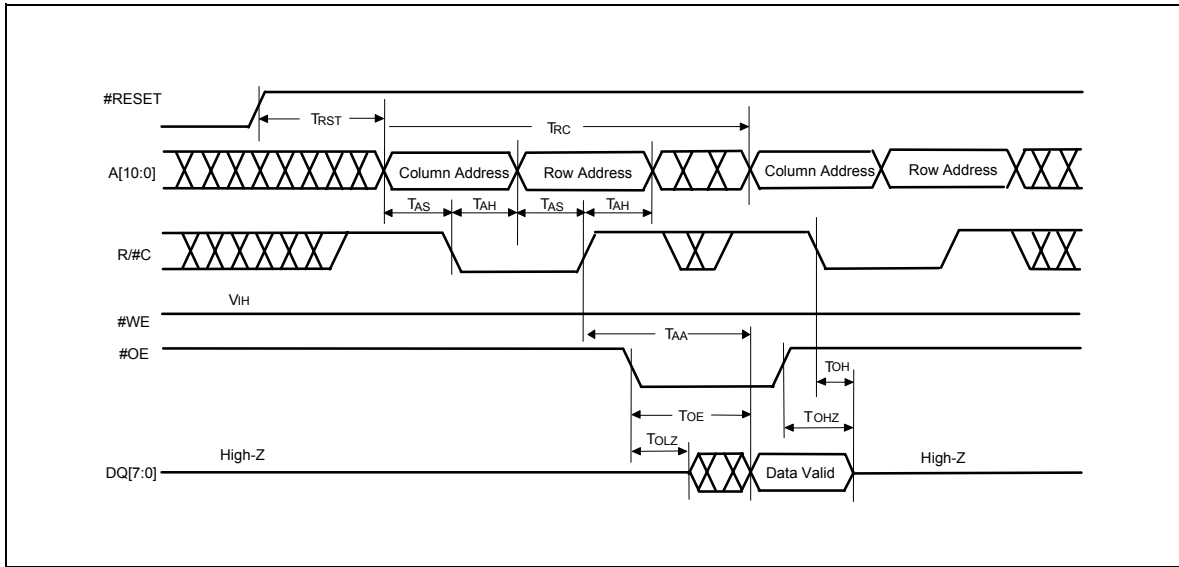


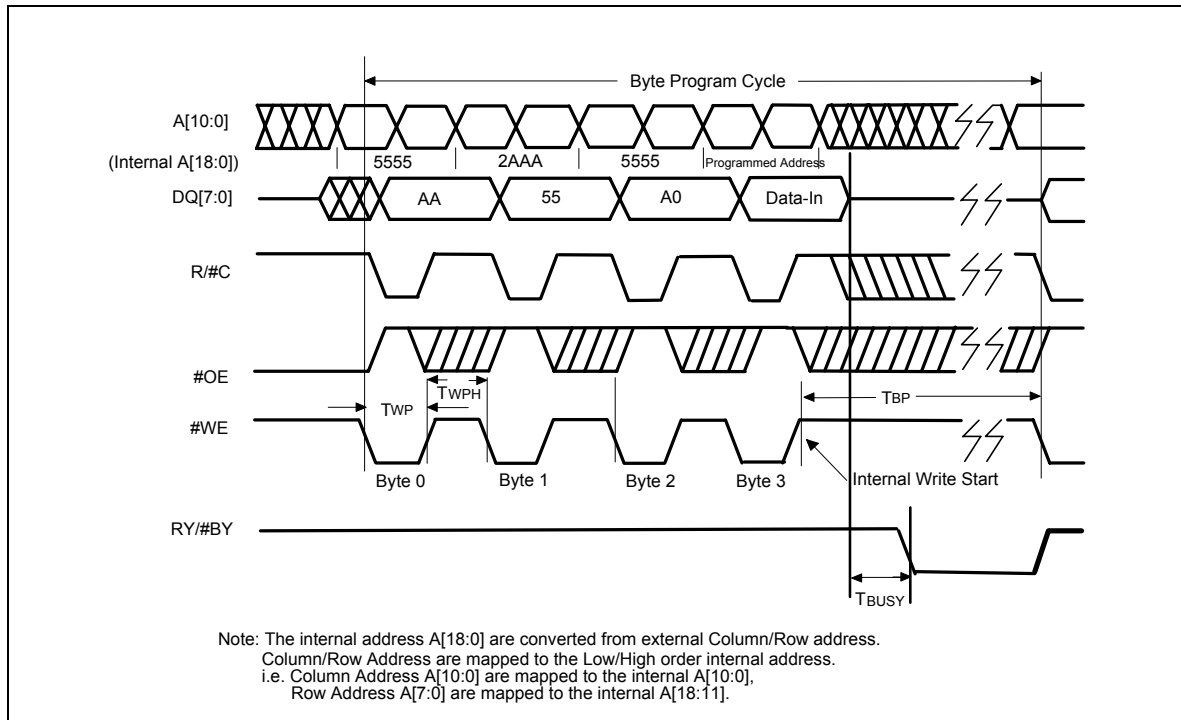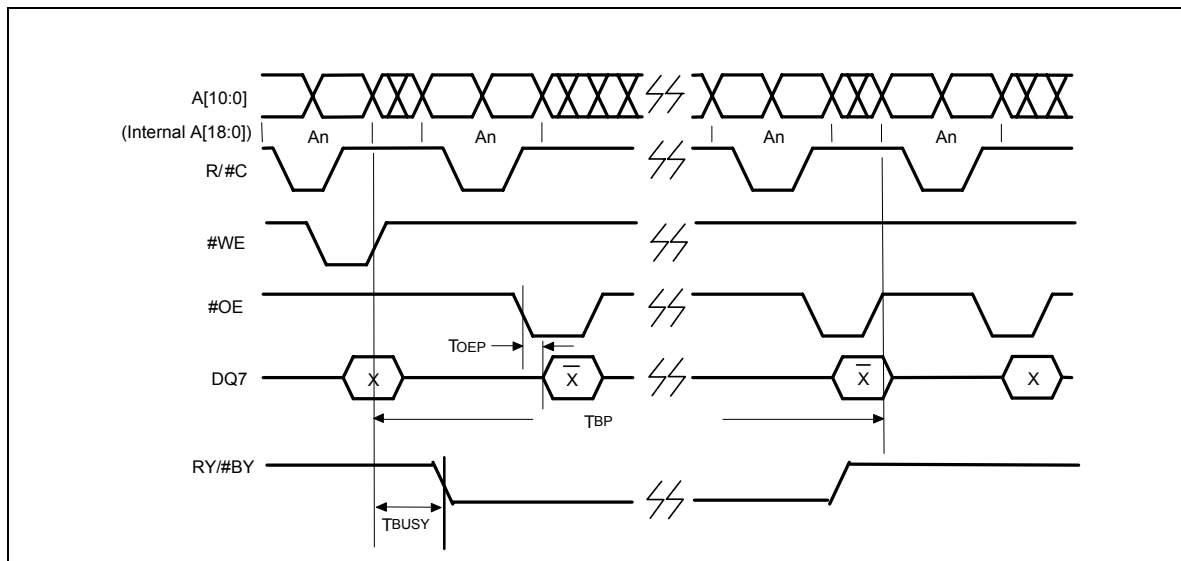### 11.2 Write Cycle Timing Diagram

Timing Waveforms for Programmer Interface Mode, continued

## 11.3 Program Cycle Timing Diagram



Note: The internal address A[18:0] are converted from external Column/Row address.
Column/Row Address are mapped to the Low/High order internal address.
i.e. Column Address A[10:0] are mapped to the internal A[10:0],
Row Address A[7:0] are mapped to the internal A[18:11].
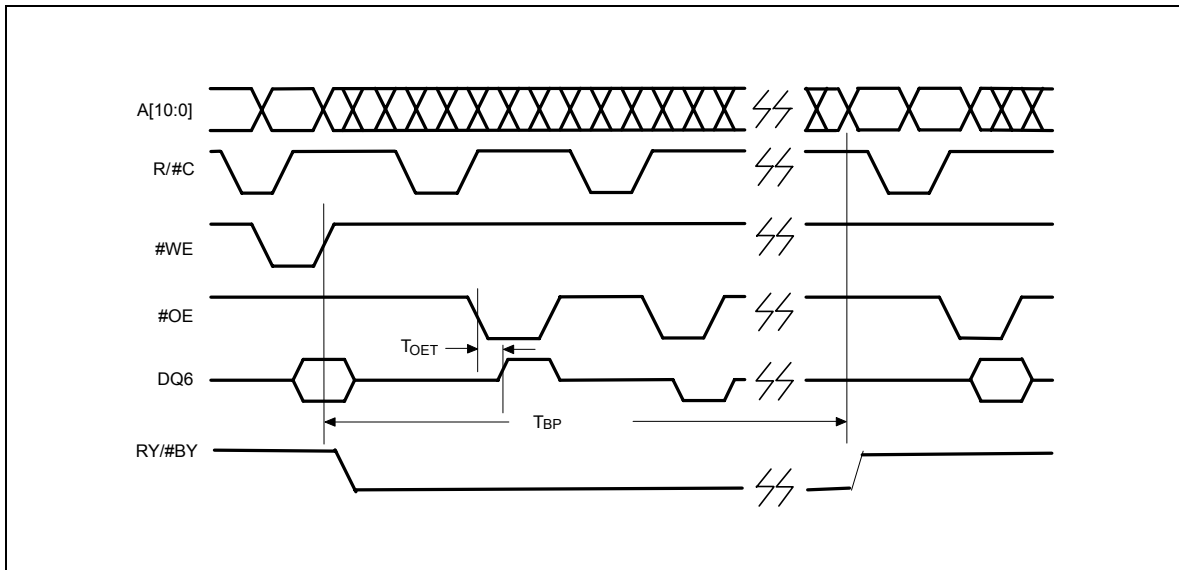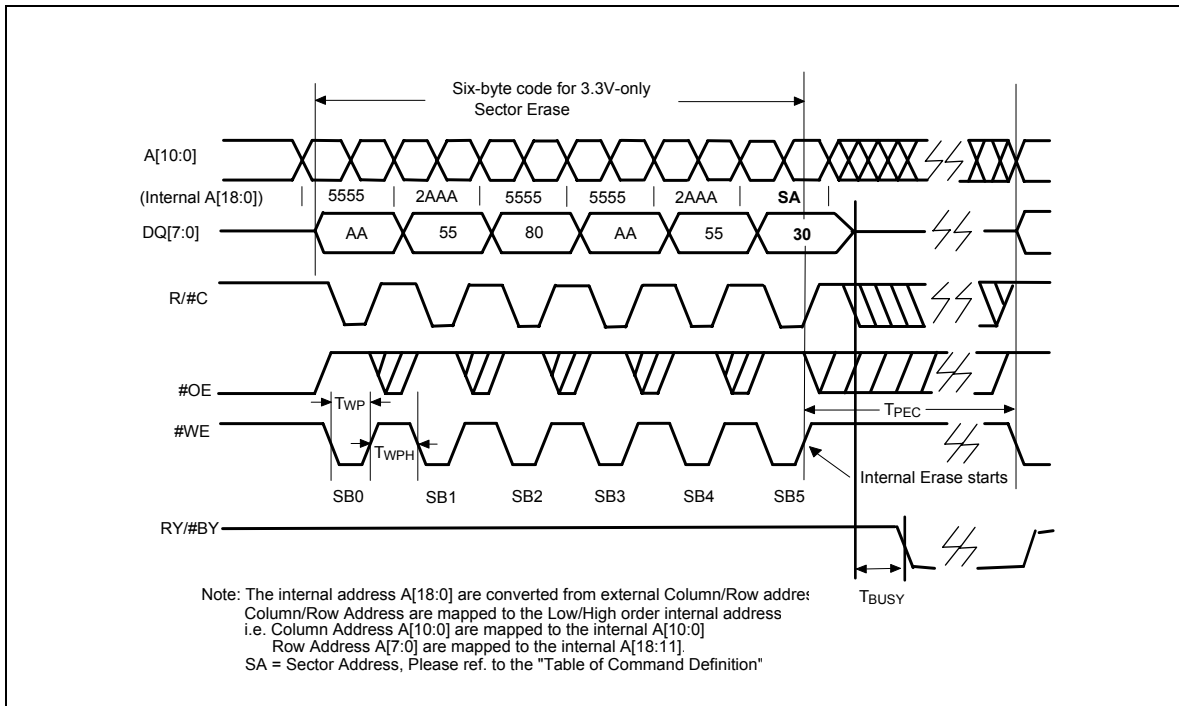
## 11.4 #DATA Polling Timing Diagram

Timing Waveforms for Programmer Interface Mode, continued

## 11.5 Toggle Bit Timing Diagram



## 11.6 Sector Erase Timing Diagram

## 12. LPC INTERFACE MODE AC CHARACTERISTICS

### 12.1 AC Test Conditions

| PARAMETER | CONDITIONS |
|---|---|
| Input Pulse Levels | 0.6 $V_{DD}$ to 0.2 $V_{DD}$ |
| Input Rise/Fall Slew Rate | 1 V/nS |
| Input/Output Timing Level | 0.4$V_{DD}$ / 0.4$V_{DD}$ |
| Output Load | 1 TTL Gate and $C_L$ = 10 pF |

### 12.2 Read/Write Cycle Timing Parameters

($V_{DD}$ = 3.3V $\pm$ 0.3V, $V_{SS}$ = 0V, $T_A$ = 0 to 70° C)

| PARAMETER | SYMBOL | W39V040B | | UNIT |
|---|---|---|---|---|
| | | MIN. | MAX. | |
| Clock Cycle Time | $T_{CYC}$ | 30 | - | nS |
| Input Set Up Time | $T_{SU}$ | 7 | - | nS |
| Input Hold Time | $T_{HD}$ | 0 | - | nS |
| Clock to Data Valid | $T_{KQ}$ | 2 | 11 | nS |

**Note:** Minimum and Maximum time have different load. Please refer to PCI specification.

### 12.3 Reset Timing Parameters

| PARAMETER | SYMBOL | MIN. | TYP. | MAX. | UNIT |
|---|---|---|---|---|---|
| $V_{DD}$ stable to Reset Active | $T_{PRST}$ | 1 | - | - | mS |
| Clock Stable to Reset Active | $T_{KRST}$ | 100 | - | - | $\mu$S |
| Reset Pulse Width | $T_{RSTP}$ | 100 | - | - | nS |
| Reset Active to Output Float | $T_{RSTF}$ | - | - | 50 | nS |
| Reset Inactive to Input Active | $T_{RST}$ | 10 | - | - | $\mu$S |

**Note:** All AC timing signals observe the following guidelines for determining setup and hold times:
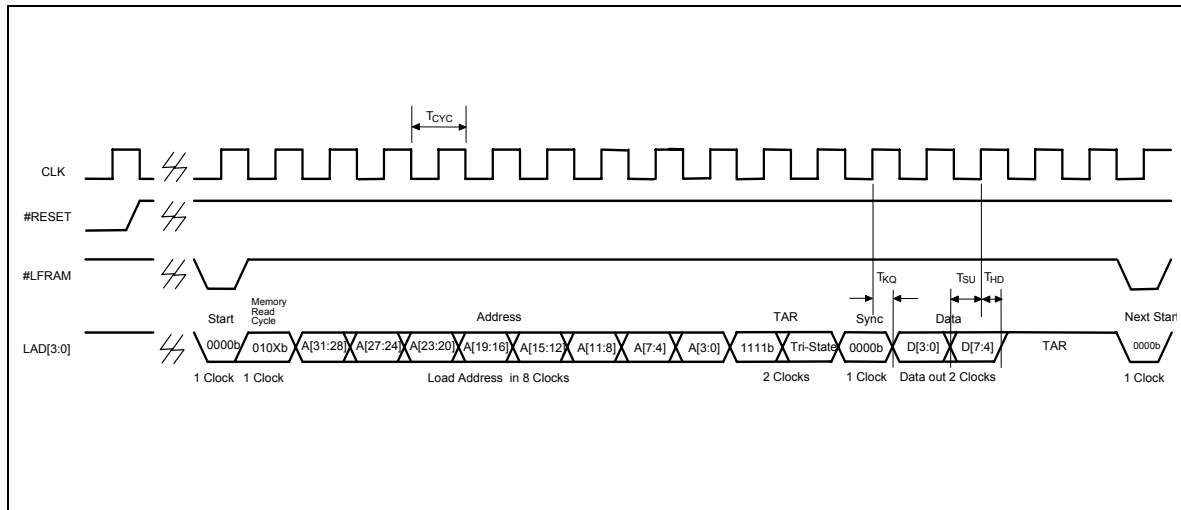(a) High level signal's reference level is input high and (b) low level signal's reference level is input low.
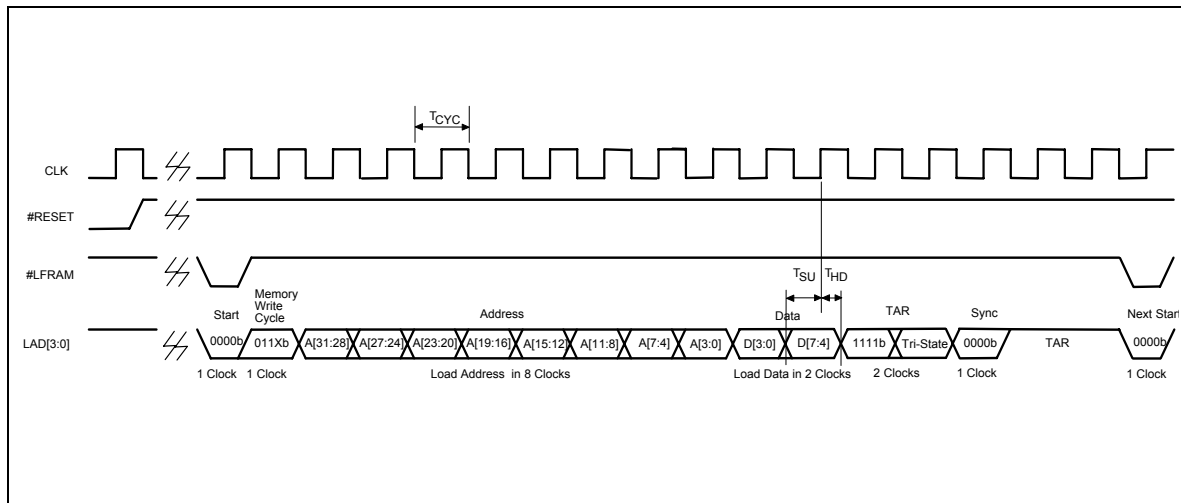Please refer to the AC testing condition.

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## 13. TIMING WAVEFORMS FOR LPC INTERFACE MODE

### 13.1 Read Cycle Timing Diagram

$T_{CYC}$

CLK

#RESET

#LFRAM

$T_{KQ}$  $T_{SU}$  $T_{HD}$

LAD[3:0]

Start | Memory Read Cycle | Address | TAR | Sync | Data | Next Start

0000b | 010Xb | A[31:28] A[27:24] A[23:20] A[19:16] A[15:12] A[11:8] A[7:4] A[3:0] | 1111b Tri-State | 0000b | D[3:0] D[7:4] | TAR | 0000b

1 Clock  1 Clock    Load Address in 8 Clocks    2 Clocks  1 Clock  Data out 2 Clocks   1 Clock

### 13.2 Write Cycle Timing Diagram

$T_{CYC}$

CLK

#RESET

#LFRAM

$T_{SU}$  $T_{HD}$

LAD[3:0]

Start | Memory Write Cycle | Address | Data | TAR | Sync | Next Start

0000b | 011Xb | A[31:28] A[27:24] A[23:20] A[19:16] A[15:12] A[11:8] A[7:4] A[3:0] | D[3:0] D[7:4] | 1111b Tri-State | 0000b | TAR | 0000b

1 Clock  1 Clock    Load Address in 8 Clocks    Load Data in 2 Clocks  2 Clocks  1 Clock   1 Clock

# W39V040B

Timing Waveforms, for LPC Interface Mode, continued

## 13.3 Program Cycle Timing Diagram



Write the 1st command to the device in LPC mode.

Write the 2nd command to the device in LPC mode.

Write the 3rd command to the device in LPC mode.

Write the 4th command(target location to be programmed) to the device in LPC mode.
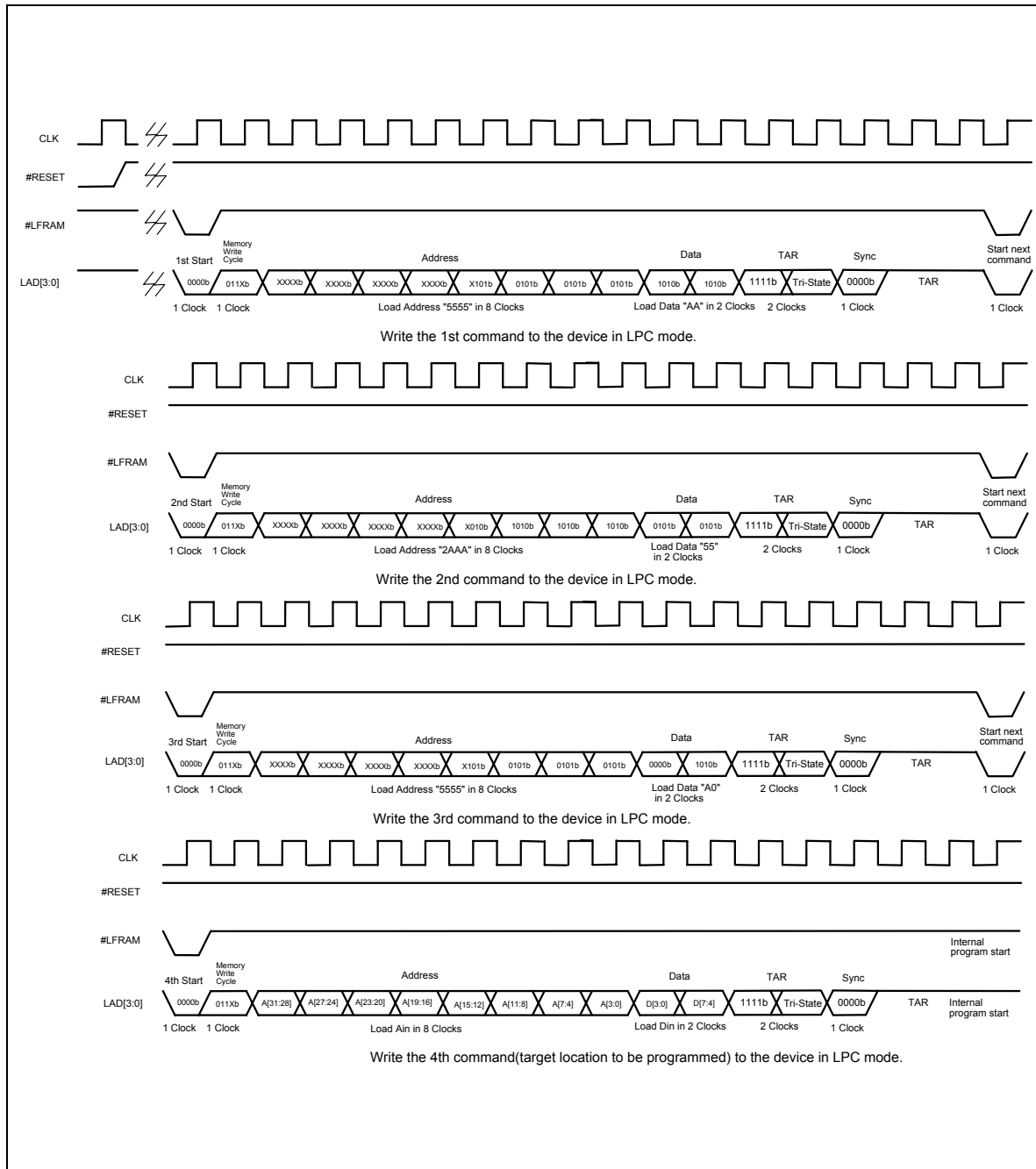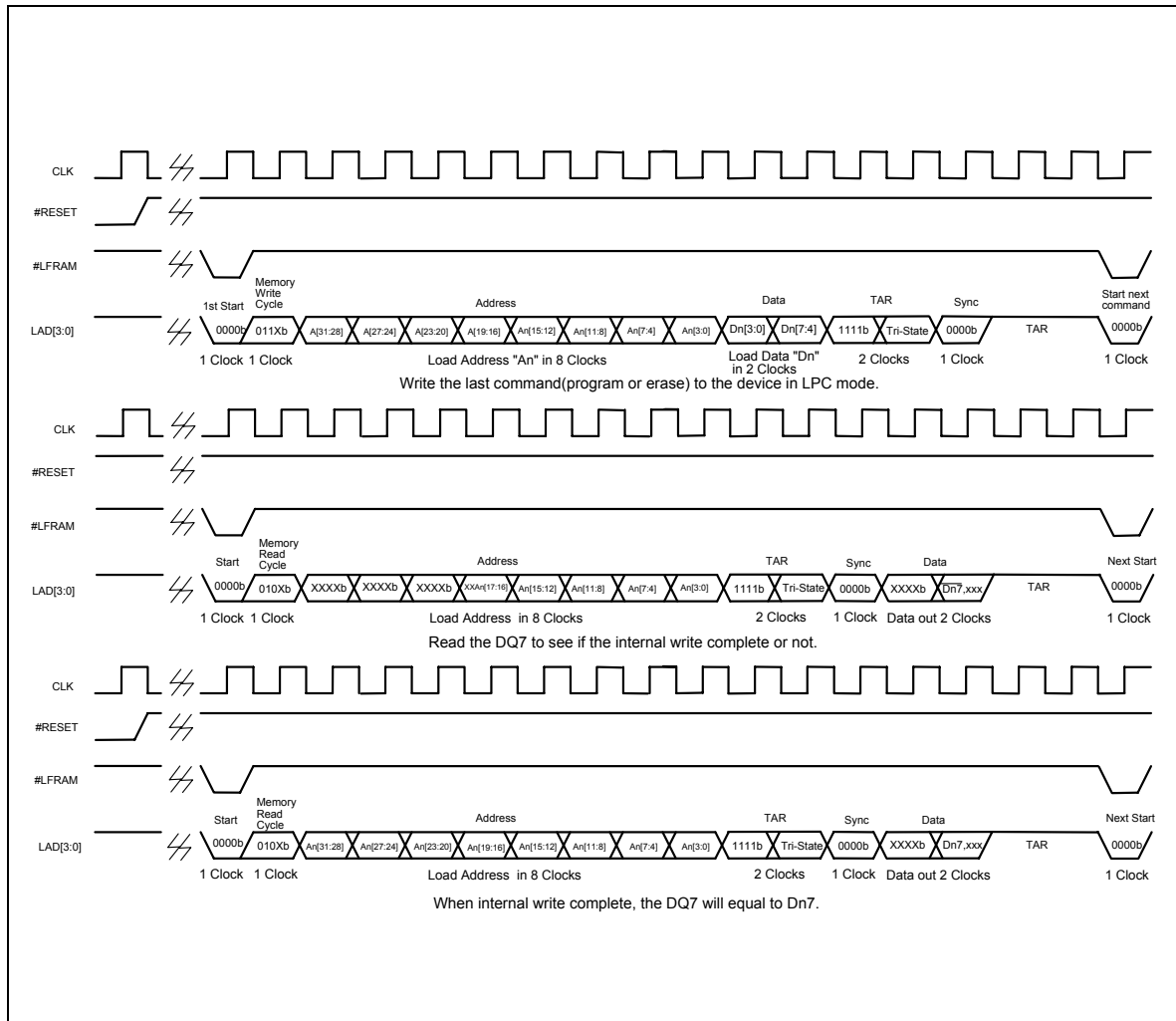
Timing Waveforms for LPC Interface Mode, continued

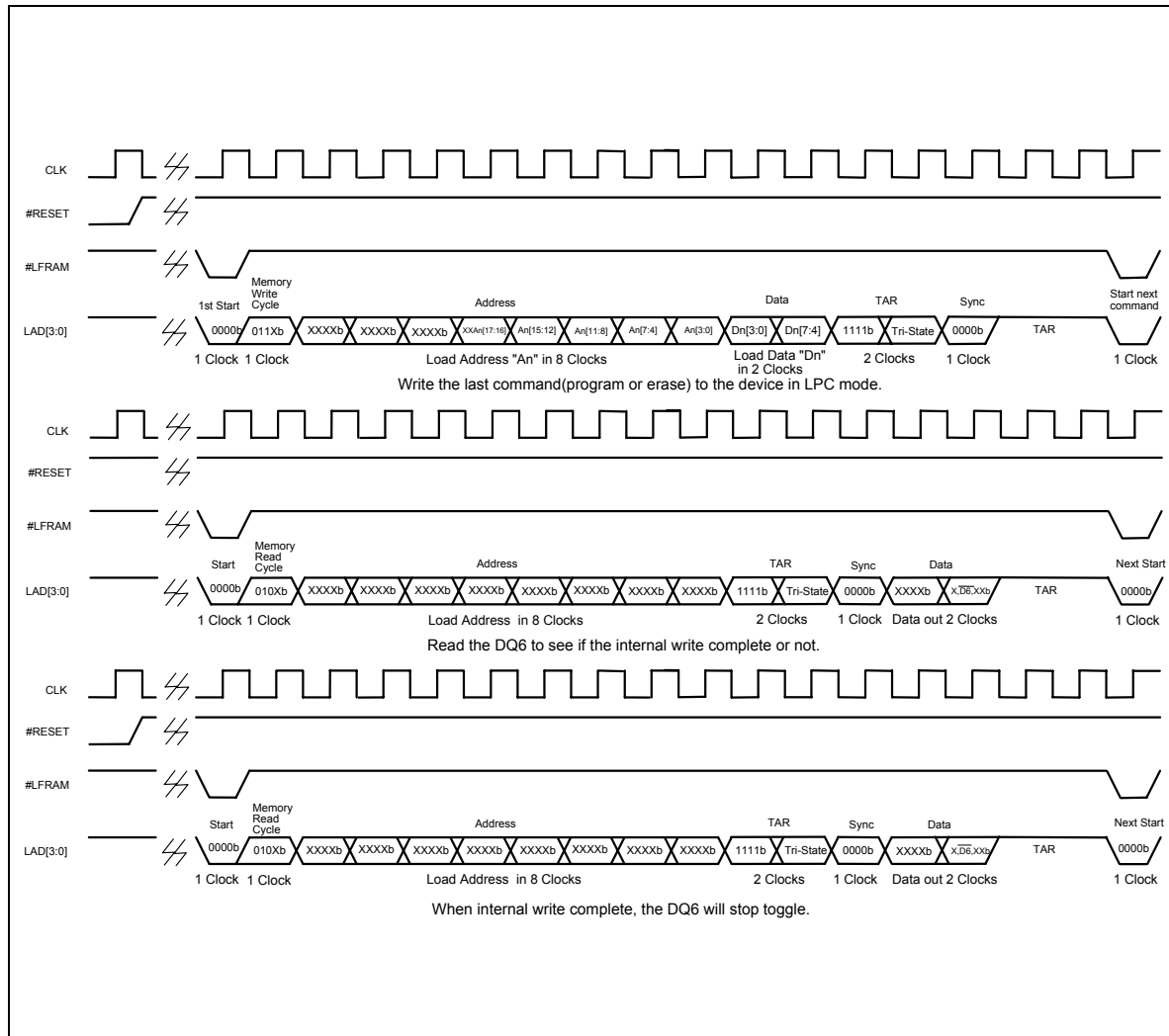## 13.4 #DATA Polling Timing Diagram
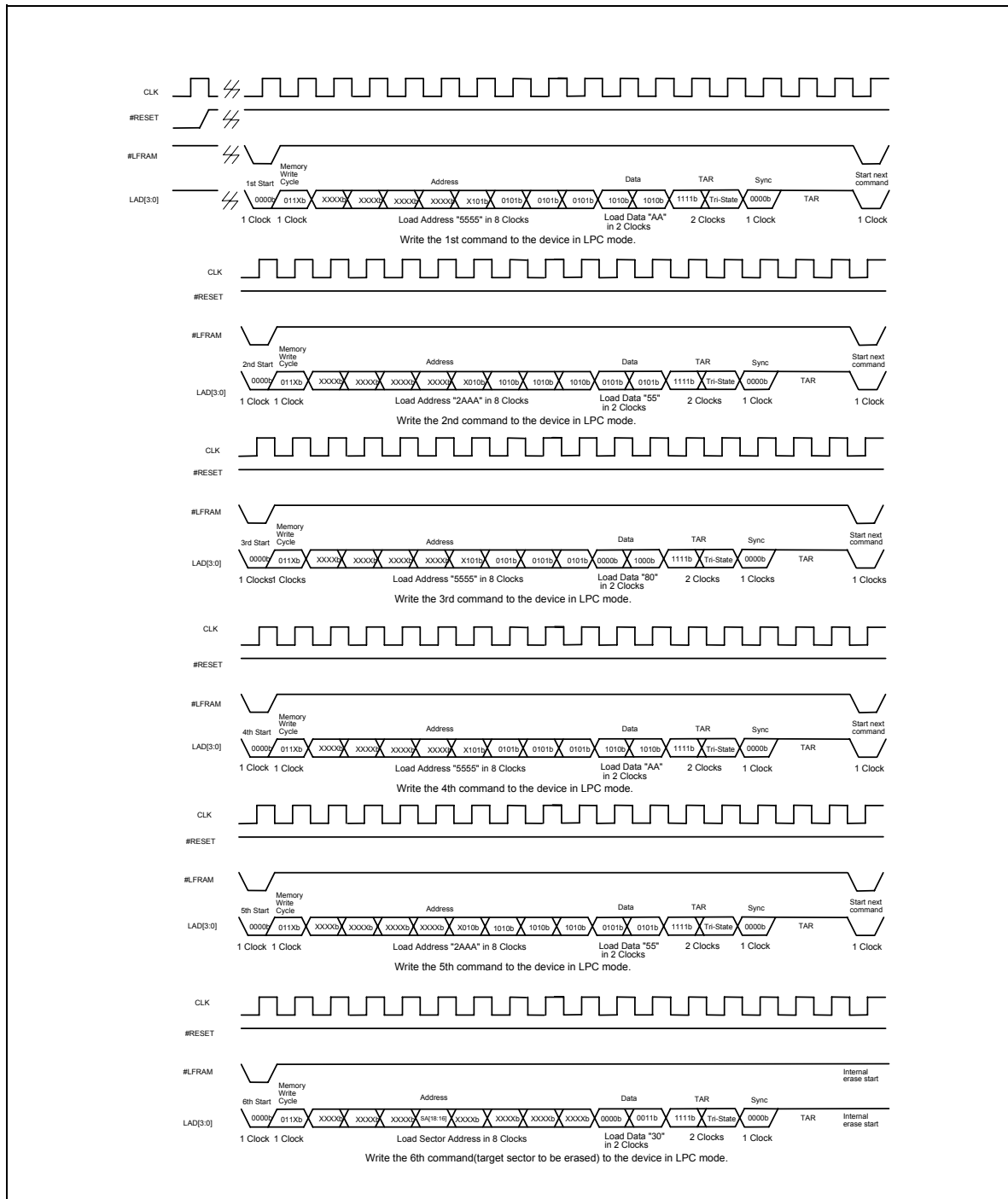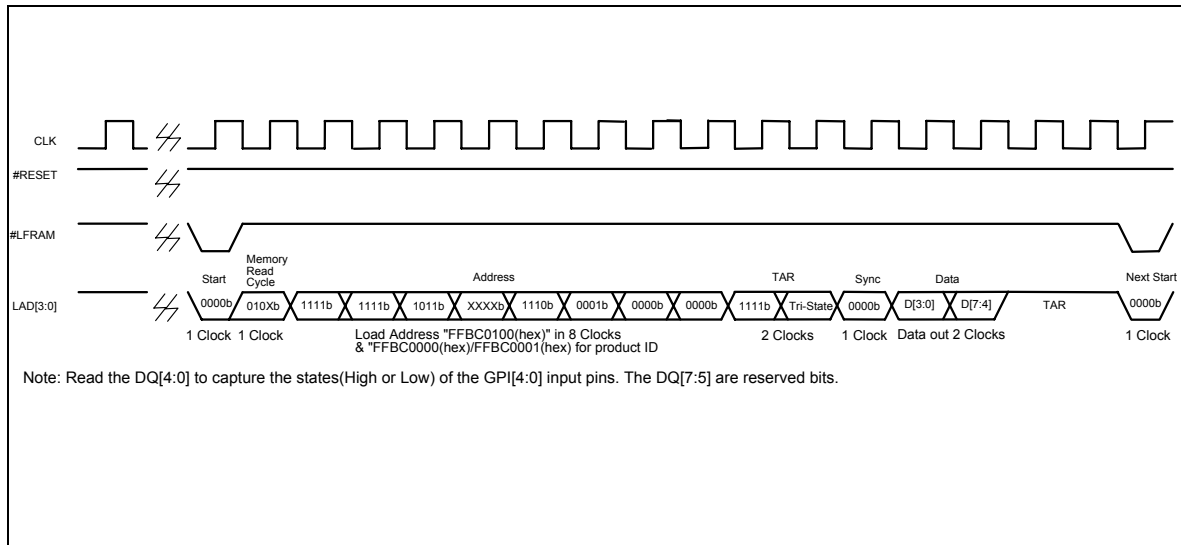
Timing Waveforms for LPC Interface Mode, continued

## 13.5 Toggle Bit Timing Diagram

# W39V040B

## 13.6 Sector Erase Timing Diagram

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Timing Waveforms for LPC Interface Mode, continued

## 13.7 FGPI Register/Product ID Readout Timing Diagram

CLK

#RESET

#LFRAM

LAD[3:0]

Start | Memory Read Cycle | Address | TAR | Sync | Data | Next Start

0000b | 010Xb | 1111b | 1111b | 1011b | XXXXb | 1110b | 0001b | 0000b | 0000b | 1111b | Tri-State | 0000b | D[3:0] | D[7:4] | TAR | 0000b

1 Clock   1 Clock   Load Address "FFBC0100(hex)" in 8 Clocks
& "FFBC0000(hex)/FFBC0001(hex) for product ID   2 Clocks   1 Clock   Data out 2 Clocks   1 Clock

Note: Read the DQ[4:0] to capture the states(High or Low) of the GPI[4:0] input pins. The DQ[7:5] are reserved bits.

## 13.8 Reset Timing Diagram

VDD

$T_{PRST}$

CLK

$T_{KRST}$

#RESET

$T_{RSTP}$

$T_{RST}$

LAD[3:0]

$T_{RST}$

#LFRAM
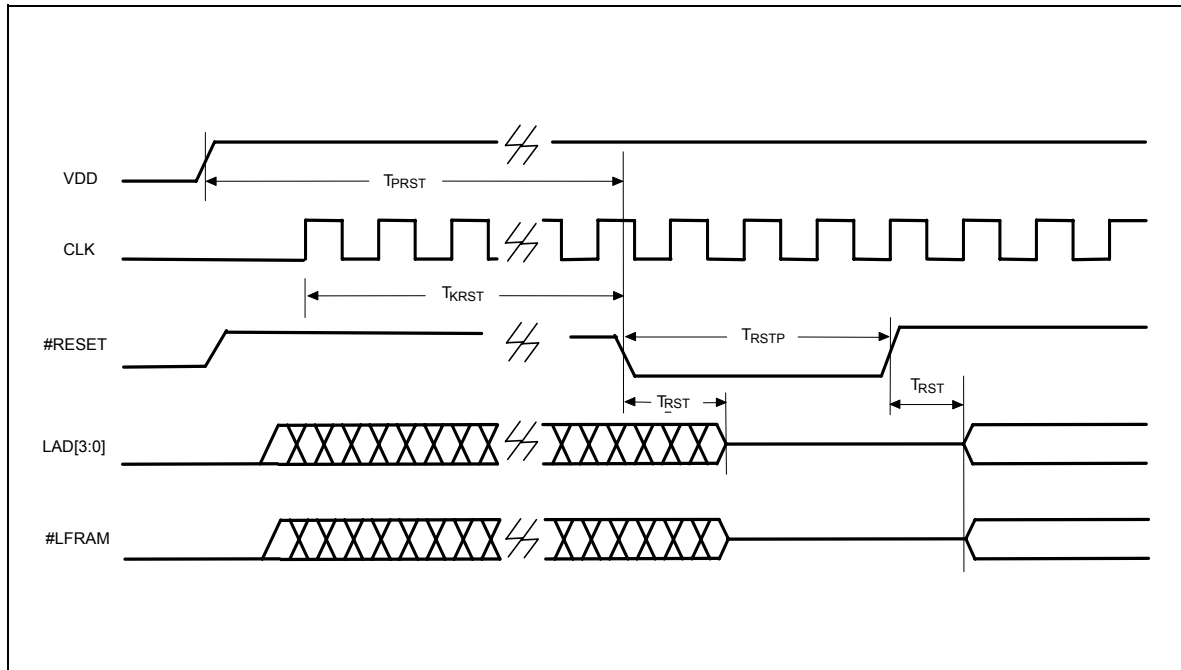
## 14. ORDERING INFORMATION

| PART NO. | ACCESS TIME (nS) | POWER SUPPLY CURRENT MAX. (mA) | STANDBY VDD CURRENT MAX. (mA) | PACKAGE |
|---|---|---|---|---|
| W39V040BP | 11 | 30 | 10 | 32L PLCC |
| W39V040BQ | 11 | 30 | 10 | 32L STSOP |
| W39V040BPZ | 11 | 30 | 10 | 32L PLCC Lead free |
| W39V040BQZ | 11 | 30 | 10 | 32L STSOP Lead free |

**Notes:**

1. Winbond reserves the right to make changes to its products without prior notice.

2. Purchasers are responsible for performing appropriate quality assurance testing on products intended for use in applications where personal injury might occur as a consequence of product failure.

## 15. HOW TO READ THE TOP MARKING

Example: The top marking of 32-pin STSOP W39V040BQZ



W39V040BQZ
2138977A-A12
345OBFA

1$^{st}$ line: Winbond logo

2$^{nd}$ line: the part number: W39V040BQZ (Z: Lead free part)

3$^{rd}$ line: the lot number

4$^{th}$ line: the tracking code: 345 O B FA

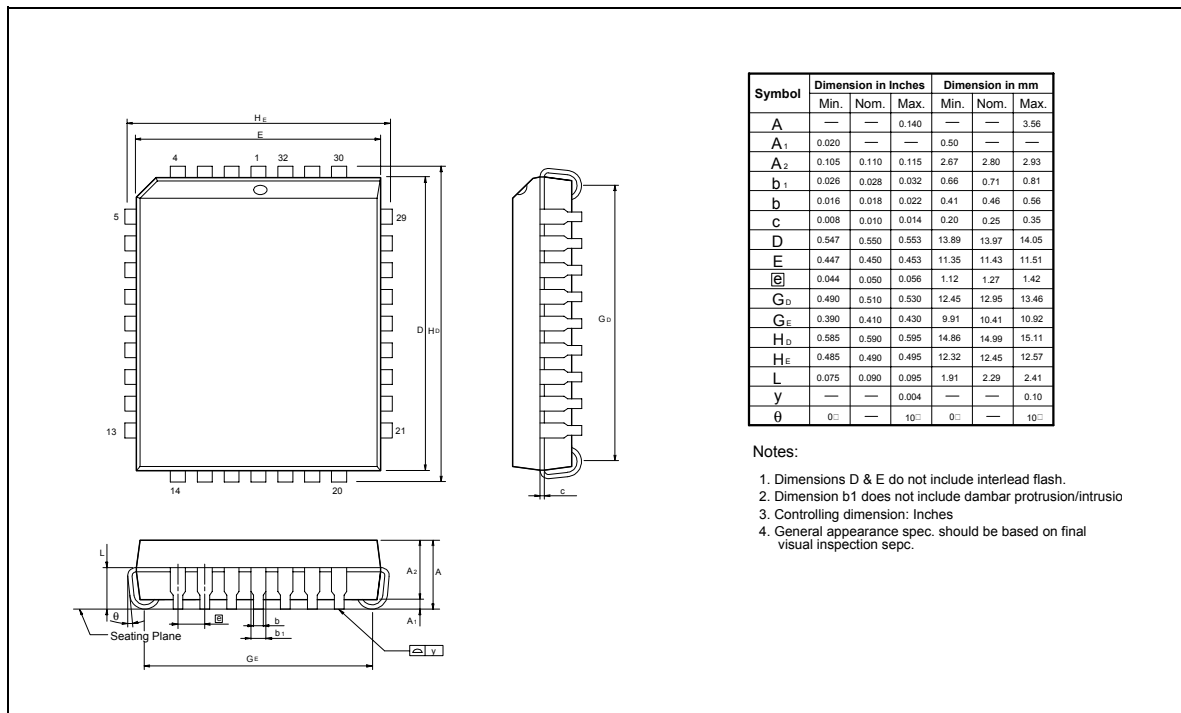       149: Packages made in '03, week 45

       O: Assembly house ID: A means ASE, O means OSE, ...etc.

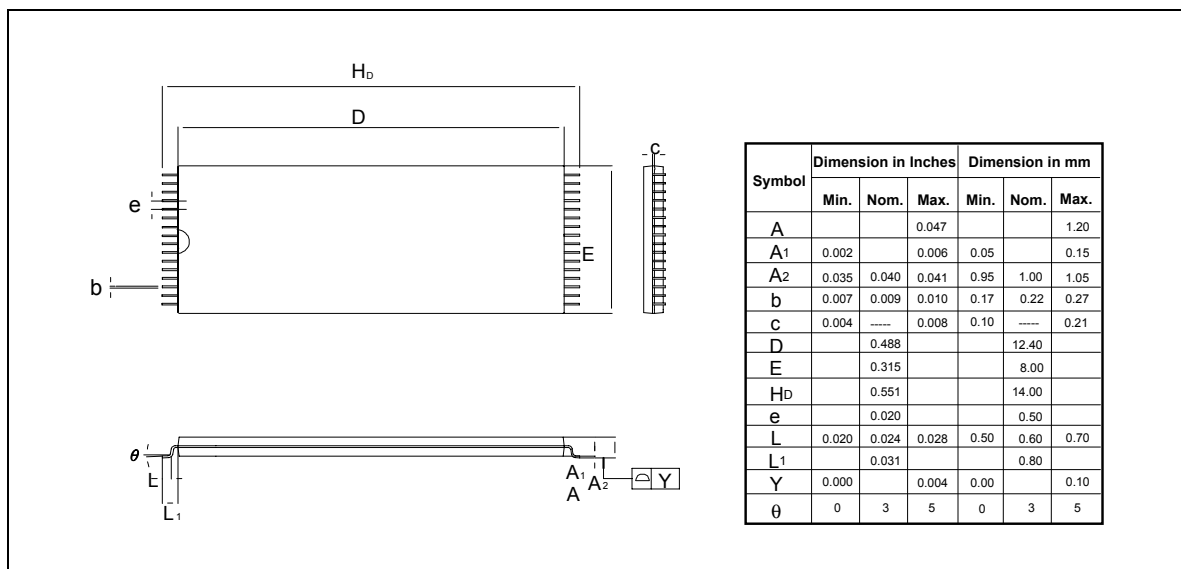       B: ic revision; A means version A, B means version B, ...etc.

       FA: Process code

## 16. PACKAGE DIMENSIONS

### 16.1 32L PLCC



| Symbol | Dimension in Inches | | | Dimension in mm | | |
|---|---|---|---|---|---|---|
| | Min. | Nom. | Max. | Min. | Nom. | Max. |
| A | — | — | 0.140 | — | — | 3.56 |
| A$_1$ | 0.020 | — | — | 0.50 | — | — |
| A$_2$ | 0.105 | 0.110 | 0.115 | 2.67 | 2.80 | 2.93 |
| b$_1$ | 0.026 | 0.028 | 0.032 | 0.66 | 0.71 | 0.81 |
| b | 0.016 | 0.018 | 0.022 | 0.41 | 0.46 | 0.56 |
| c | 0.008 | 0.010 | 0.014 | 0.20 | 0.25 | 0.35 |
| D | 0.547 | 0.550 | 0.553 | 13.89 | 13.97 | 14.05 |
| E | 0.447 | 0.450 | 0.453 | 11.35 | 11.43 | 11.51 |
| e | 0.044 | 0.050 | 0.056 | 1.12 | 1.27 | 1.42 |
| G$_D$ | 0.490 | 0.510 | 0.530 | 12.45 | 12.95 | 13.46 |
| G$_E$ | 0.390 | 0.410 | 0.430 | 9.91 | 10.41 | 10.92 |
| H$_D$ | 0.585 | 0.590 | 0.595 | 14.86 | 14.99 | 15.11 |
| H$_E$ | 0.485 | 0.490 | 0.495 | 12.32 | 12.45 | 12.57 |
| L | 0.075 | 0.090 | 0.095 | 1.91 | 2.29 | 2.41 |
| y | — | — | 0.004 | — | — | 0.10 |
| θ | 0 | — | 10 | 0 | — | 10 |

Notes:

1. Dimensions D & E do not include interlead flash.
2. Dimension b1 does not include dambar protrusion/intrusio
3. Controlling dimension: Inches
4. General appearance spec. should be based on final visual inspection sepc.

### 16.2 32L STSOP



| Symbol | Dimension in Inches | | | Dimension in mm | | |
|---|---|---|---|---|---|---|
| | Min. | Nom. | Max. | Min. | Nom. | Max. |
| A | | | 0.047 | | | 1.20 |
| A$_1$ | 0.002 | | 0.006 | 0.05 | | 0.15 |
| A$_2$ | 0.035 | 0.040 | 0.041 | 0.95 | 1.00 | 1.05 |
| b | 0.007 | 0.009 | 0.010 | 0.17 | 0.22 | 0.27 |
| c | 0.004 | ----- | 0.008 | 0.10 | ----- | 0.21 |
| D | | 0.488 | | | 12.40 | |
| E | | 0.315 | | | 8.00 | |
| H$_D$ | | 0.551 | | | 14.00 | |
| e | | 0.020 | | | 0.50 | |
| L | 0.020 | 0.024 | 0.028 | 0.50 | 0.60 | 0.70 |
| L$_1$ | | 0.031 | | | 0.80 | |
| Y | 0.000 | | 0.004 | 0.00 | | 0.10 |
| θ | 0 | 3 | 5 | 0 | 3 | 5 |

## 17. VERSION HISTORY

| VERSION | DATE | PAGE | DESCRIPTION |
|---------|------|------|-------------|
| A1 | Nov. 26, 2004 | - | Initial Issued |
| A2 | Jan.25, 2005 | P8, P9, P10 | Delete 7.3 ~ 7.7 item<br>Block lock relate description |
| A3 | April 14, 2005 | P32 | Add important notice |

### Important Notice

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